# **IGBT - Field Stop II**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications.

#### Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb–Free Devices

#### **Typical Applications**

- Solar Inverters
- Uninterruptible Power Supplies (UPS)
- Welding

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CES</sub>	650	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>c</sub>	70 35	A
Pulsed collector current, $T_{pulse}$ limited by $T_{Jmax}$	I <sub>CM</sub>	120	A
Short–circuit withstand time $V_{GE} = 15 \text{ V}, V_{CE} = 400 \text{ V}, T_J \leq +150^{\circ}\text{C}$	t <sub>SC</sub>	5	μs
Gate-emitter voltage	$V_{GE}$	±20	V
Transient gate-emitter voltage $(T_{PULSE} = 5 \ \mu s, D < 0.10)$		±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P <sub>D</sub>	300 150	W
Operating junction temperature range	Τ <sub>J</sub>	-55 to +175	°C
Storage temperature range	T <sub>stg</sub>	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

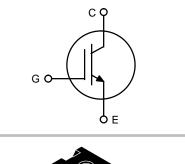
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



# **ON Semiconductor®**

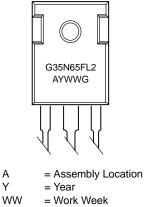
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35 A, 650 V V<sub>CEsat</sub> = 1.70 V  $E_{OFF} = 0.28 \text{ mJ}$ 





#### MARKING DIAGRAM



G = Pb-Free Package

А

Y

#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTG35N65FL2WG	TO–247 (Pb–Free)	30 Units / Rail

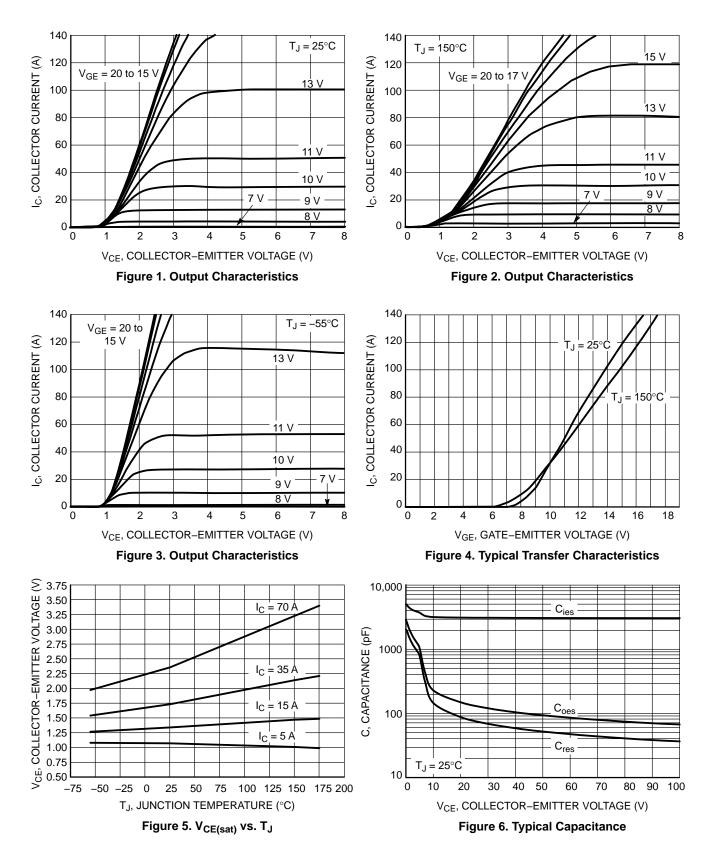
#### THERMAL CHARACTERISTICS

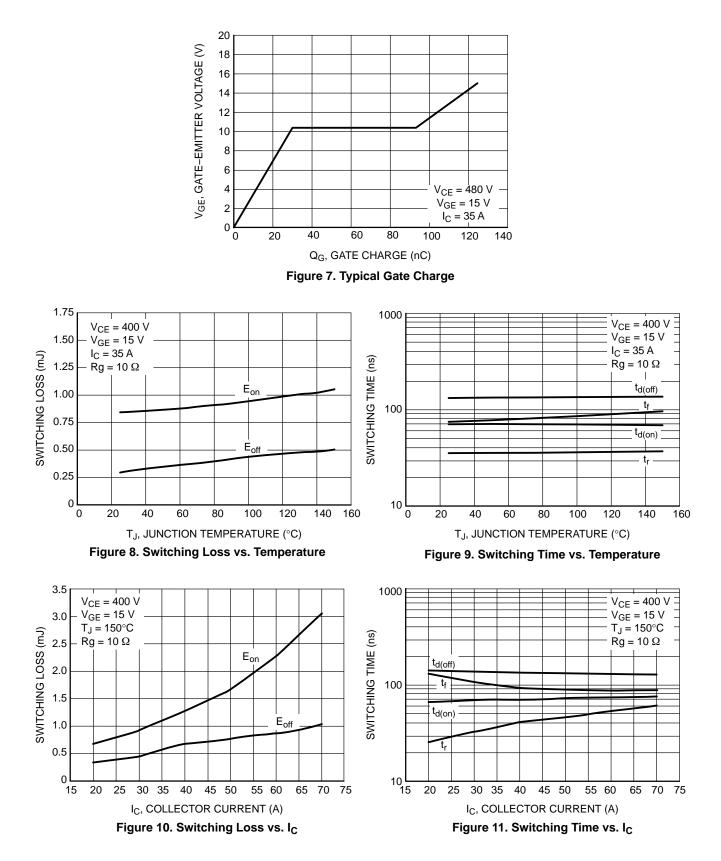
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.50	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

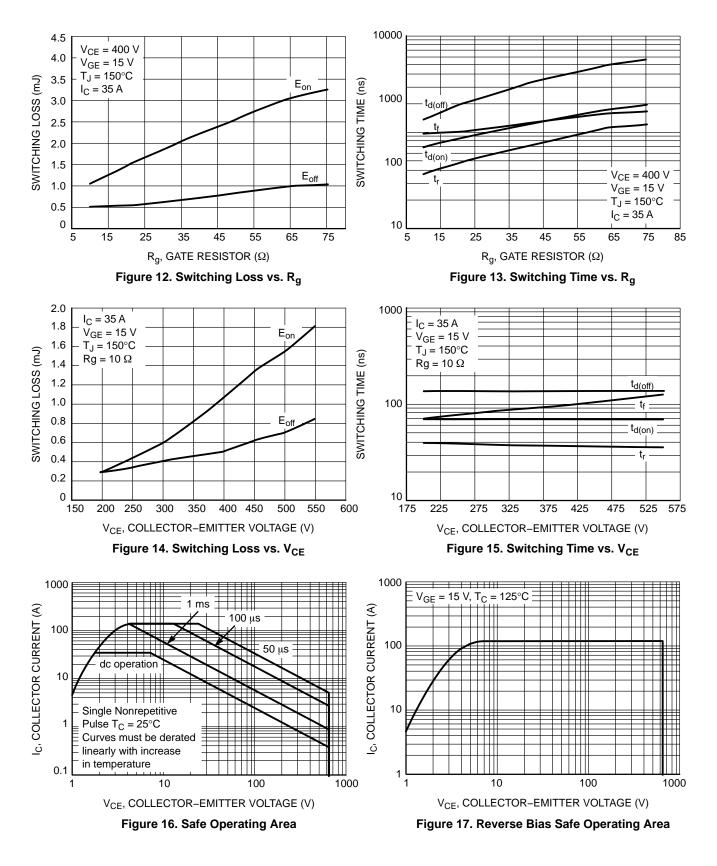
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE}$ = 0 V, I <sub>C</sub> = 500 µA	V <sub>(BR)CES</sub>	650	-	-	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 35 A $V_{GE}$ = 15 V, I <sub>C</sub> = 35 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>	1.50 -	1.70 2.20	2.00	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector–emitter cut–off current, gate– emitter short–circuited	$V_{GE} = 0 V, V_{CE} = 650 V$ $V_{GE} = 0 V, V_{CE} = 650 V, T_{J} = 175^{\circ}C$	I <sub>CES</sub>	-		0.5 4.0	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$ , $V_{CE} = 0 \text{ V}$	I <sub>GES</sub>	_	-	200	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		Cies	_	3115	-	pF
Output capacitance	$V_{CE}$ = 20 V, $V_{GE}$ = 0 V, f = 1 MHz	C <sub>oes</sub>	-	149	-	
Reverse transfer capacitance		Cres	-	88	-	
Gate charge total		Qg	-	125	-	nC
Gate to emitter charge	$V_{CE}$ = 480 V, I <sub>C</sub> = 35 A, V <sub>GE</sub> = 15 V	Q <sub>ge</sub>	-	30	-	
Gate to collector charge		Q <sub>gc</sub>	-	63	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t <sub>d(on)</sub>	-	72	-	ns
Rise time		t <sub>r</sub>	-	40	-	
Turn-off delay time	$T_J = 25^{\circ}C$	t <sub>d(off)</sub>	-	132	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 35 \text{ A}$ $R_{g} = 10 \Omega$	t <sub>f</sub>	-	75	-	
Turn-on switching loss	$V_{GE} = 0 V/15 V^*$	Eon	-	0.84	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	0.28	-	
Total switching loss		E <sub>ts</sub>	_	1.12	-	
Turn-on delay time		t <sub>d(on)</sub>	-	70	-	ns
Rise time		t <sub>r</sub>	-	38	-	
Turn–off delay time	T <sub>J</sub> = 150°C	t <sub>d(off)</sub>	-	135	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 35 \text{ A}$ $R_{g} = 10 \Omega$	t <sub>f</sub>	-	96	-	
Turn–on switching loss	V <sub>GE</sub> = 0 V/ 15 V*	Eon	_	1.05	-	mJ
	-			0.50		
Turn–off switching loss		E <sub>off</sub>	-	0.50	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. \*Includes diode reverse recovery loss using NGTG35N65FL2WG.







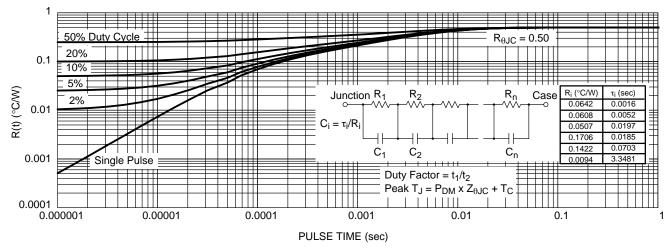
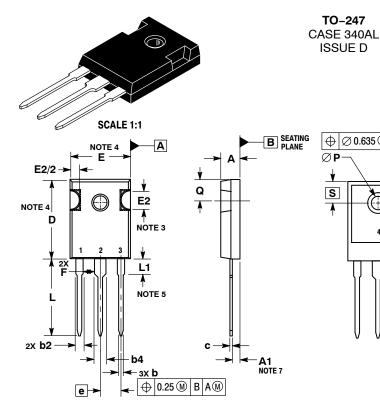


Figure 18. IGBT Transient Thermal Impedance

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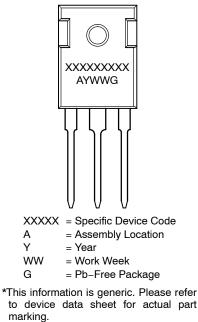
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NOTES

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. SLOT REQUIRED, NOTCH MAY BE ROUNDED. 1
- 2. 3.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
- LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY 5.
- L1. 6.
- ⊘P SHALL HAVE A MAXIMUM DRAFT ANGLE OF 1.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 3.91.
- 7. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED

BY L1.				
	MILLIMETERS			
DIM	MIN	MAX		
Α	4.70	5.30		
A1	2.20	2.60		
b	1.07	1.33		
b2	1.65	2.35		
b4	2.60	3.40		
C	0.45	0.68		
D	20.80	21.34		
Е	15.50	16.25		
E2	4.32	5.49		
е	5.45 BSC			
F	2.655			
L	19.80	20.80		
L1	3.81	4.32		
Ρ	3.55	3.65		
Q	5.40	6.20		
S	6.15 BSC			

GENERIC **MARKING DIAGRAM\*** 



Pb-Free indicator, "G" or microdot " .", may or may not be present.

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